

SPECIFICATION

- Supplier : Samsung electro-mechanics
- Product : Multi-layer Ceramic Capacitor
- Samsung P/N : **CL21B474KBFNFNG**
- Description : **CAP, 470nF, 50V, ±10%, X7R, 0805**

A. Samsung Part Number

CL **21** **B** **474** **K** **B** **F** **N** **F** **N** **G**
 ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪

① Series	Samsung Multi-layer Ceramic Capacitor						
② Size	0805 (inch code)	L: 2.0 ± 0.1	mm	W: 1.25 ± 0.1	mm		
③ Dielectric	X7R			⑧ Inner electrode	Ni		
④ Capacitance	470 nF			Termination	Cu		
⑤ Capacitance tolerance	±10 %			Plating	Sn 100% (Pb Free)		
⑥ Rated Voltage	50 V			⑨ Product	Product for POWER application		
⑦ Thickness	1.25 ± 0.1	mm			⑩ Special	Reserved for future use	
					⑪ Packaging	Embossed Type, 7"reel(3,000ea)	

B. Samsung Reliability Test and Judgement condition

	Performance	Test condition
Capacitance	Within specified tolerance	1kHz±10% 1.0±0.2Vrms
Tan δ (DF)	0.1 max.	
Insulation Resistance	More than 100Mohm·μF	Rated Voltage 60~120 sec.
Appearance	No abnormal exterior appearance	Visual inspection
Withstanding Voltage	No dielectric breakdown or mechanical breakdown	250% of the rated voltage
Temperature Characteristics	X7R (From -55℃ to 125℃, Capacitance change should be within ±15%)	
Adhesive Strength of Termination	No peeling shall be occur on the terminal electrode	500g·F, for 10±1 sec.
Bending Strength	Capacitance change : within ±12.5%	Bending to the limit (1mm) with 1.0mm/sec.
Solderability	More than 75% of terminal surface is to be soldered newly	SnAg3.0Cu0.5 solder 245±5℃, 3±0.3sec. (preheating : 80~120℃ for 10~30sec.)
Resistance to Soldering heat	Capacitance change : within ±7.5% Tan δ, IR : initial spec.	Solder pot : 270±5℃, 10±1sec.

	Performance	Test condition
Vibration Test	Capacitance change : within $\pm 5\%$ Tan δ , IR : initial spec.	Amplitude : 1.5mm From 10Hz to 55Hz (return : 1min.) 2hours \times 3 direction (x, y, z)
Moisture Resistance	Capacitance change : within $\pm 12.5\%$ Tan δ : 0.125 max IR : More than 12.5M $\Omega \cdot \mu F$	With rated voltage 40 $\pm 2^{\circ}C$, 90~95%RH, 500+12/-0 hours
High Temperature Resistance	Capacitance change : within $\pm 12.5\%$ Tan δ : 0.125 max IR : More than 25M $\Omega \cdot \mu F$	With 150% of the rated voltage Max. operating temperature 1000+48/-0 hours
Temperature Cycling	Capacitance change : within $\pm 7.5\%$ Tan δ , IR : initial spec.	1 cycle condition Min. operating temperature $\rightarrow 25^{\circ}C$ \rightarrow Max. operating temperature $\rightarrow 25^{\circ}C$ 5 cycles test

C. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 260+0/-5 $^{\circ}C$, 10sec. Max)

* For the more detail Specification, Please refer to the Samsung MLCC catalogue.